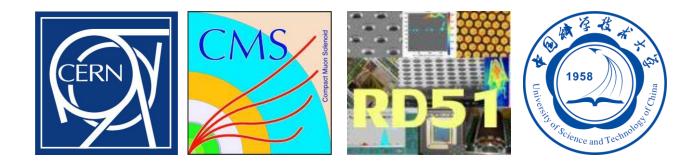
Quality Control Chamber Production Yi Zhou

University of Science & Technology of China



Outline

The Quality control of:

The drift electrodes
The GEM foils
The frames
The readout PCBs
The effective gas gain & gain uniformity
The gas leakage of the Chambers

QC-Drift Electrode 1

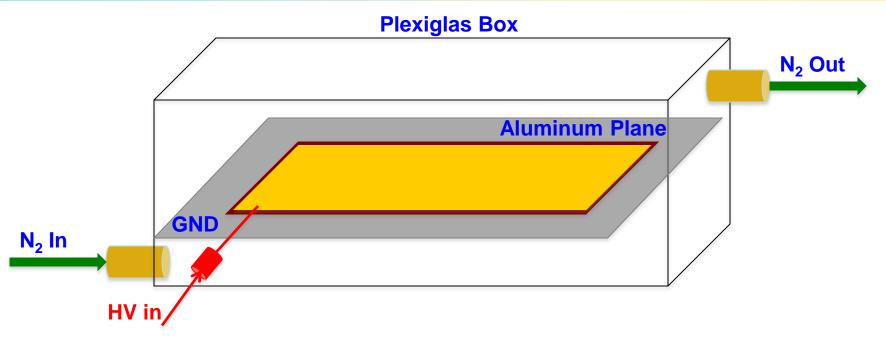
Optical inspection

The surface of the drift electrode should be smooth, no scratch and defect on it;

No drift electrode is rejected by the optical inspection until now.(From Rui)

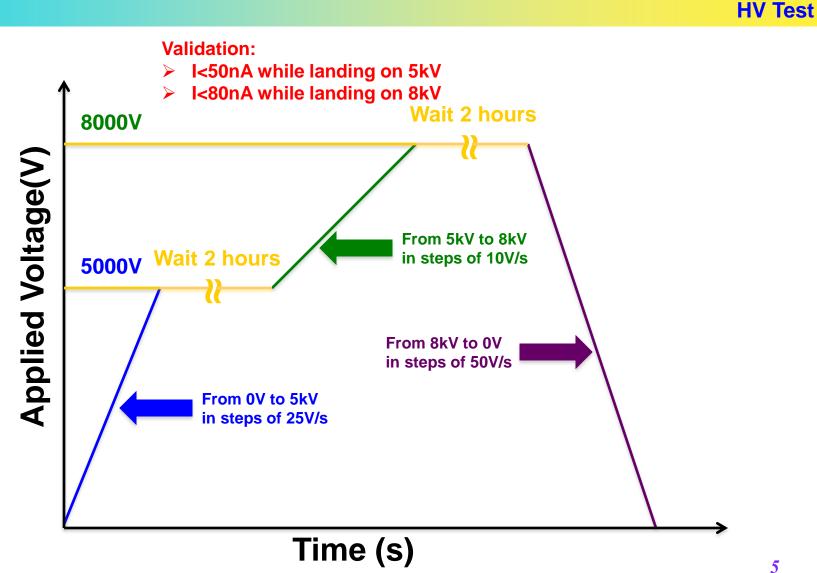
QC-Drift Electrode 2

Preparation for the HV Test

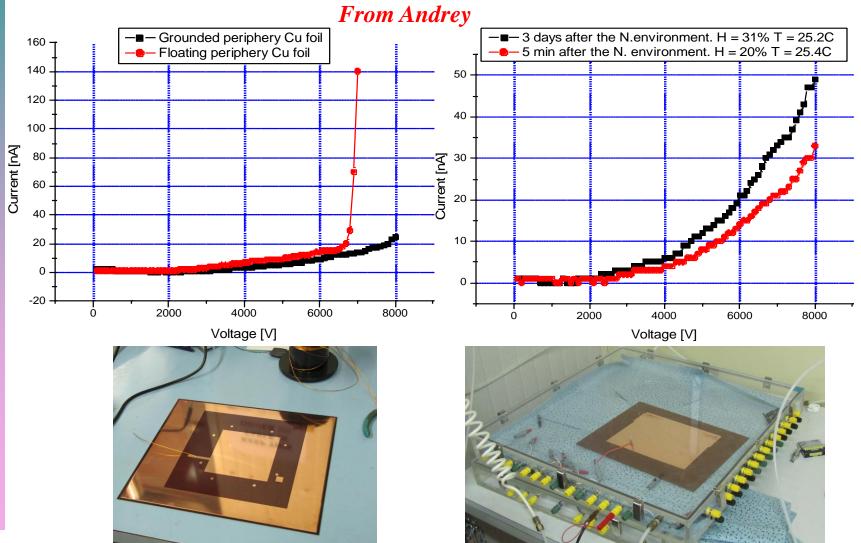


- Use the nitrogen gun to clean the electrode gently;
- Put the electrode on the aluminum ground plane(the kapton side towards the aluminum plane), connect the electrode to the HV power supply;
- close the Plexiglas box and flush the dry nitrogen(>15 liter/hour) for 2~3 hours;

QC-Drift Electrode 3



Old Test Results



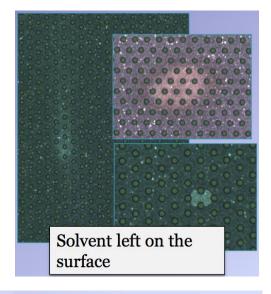
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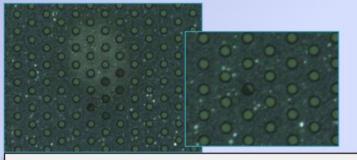
QC-GEM foils 1

Optical inspection

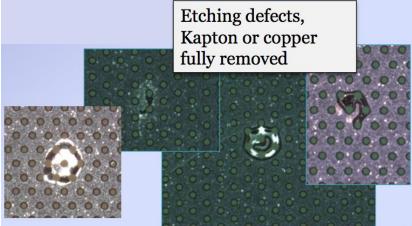
- No scratch, etching defect and incompletely etched holes;
- The maximum misalignment between kapton and copper should be less than 10µm;
- Make sure no holes are cut at the edge of each sector.

10% of the large area GEM foils are rejected by the optical inspection .(From Rui)



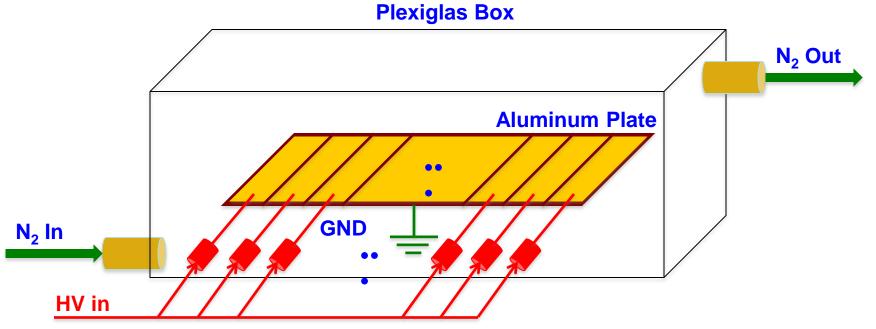


Incompletely etched holes or done only from one side



QC-GEM foils 2

Preparation for the HV Test

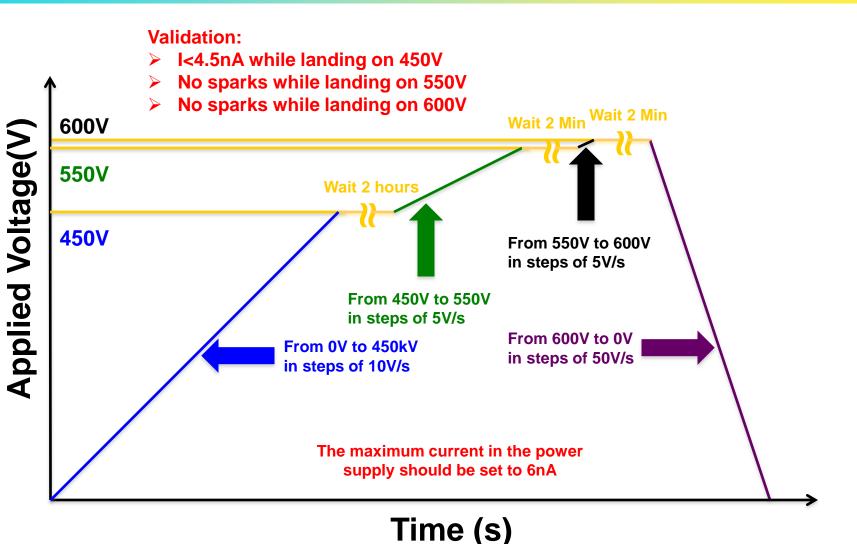


> Use the nitrogen gun to clean the GEM foil gently;

- Put the GEM foil in the Plexiglas Box, connect the non-sectored side to the ground, connect each sector to the corresponding channel of the HV power supply;
- close the Plexiglas box and flush the dry nitrogen(>15 liter/hour) for 2~3 hours;

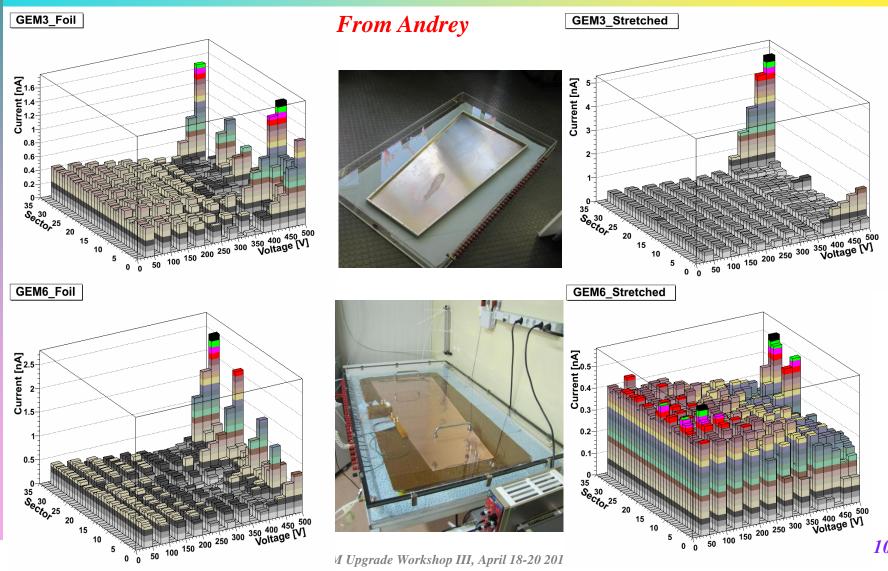
QC-GEM foils 3





Old Test Results

5 0 0



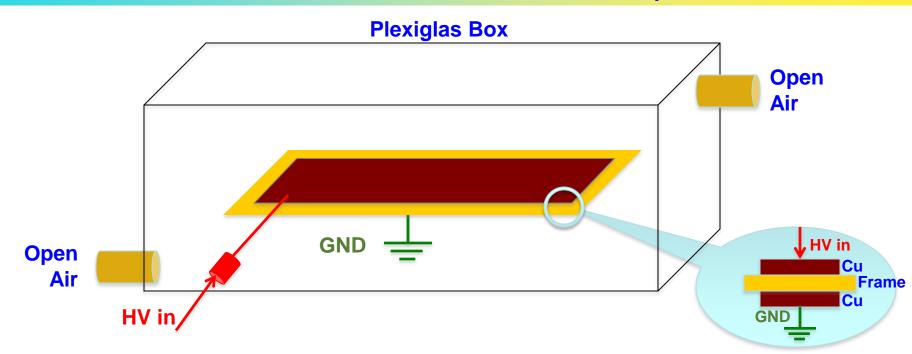
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QC-Frames 1

- The internal edge of the frame is preliminary sanded (outside the clean room);
- The part of the frame in contact with the active area of the detector should be sprayed with the Polyurethane to avoid the spikes and fibers; (This step can be ignored if the manufacture of the frames is perfect)
- Introduce the frame in a cleaning-box and fill the box with demineralized water, then place the cleaning-box in the ultrasonic bath for 4 minutes;
- The frames are dried in a oven at 40° C for about 4 hours, then stored the frames in a clean cabinet.

QC-Frames 2

Preparation for the HV Test



Put the frame between two copper planes, the top copper connects to the HV power supply, the bottom copper connects to the ground;
 This test should be done in the open air;

QC-Frames 3

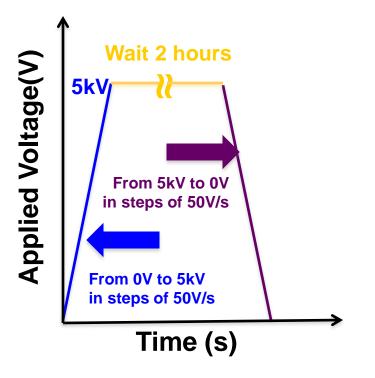
HV Test

Validation:

Hold 5kV in open air without sparks

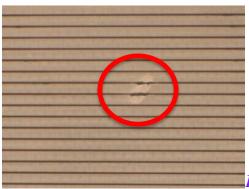
If there are sparks occur:

- Ramping down the HV, left the frame in the Plexiglas box for 2 hours;
- Test is again, if no sparks, it is ok;
- If there are still sparks, clean it again.

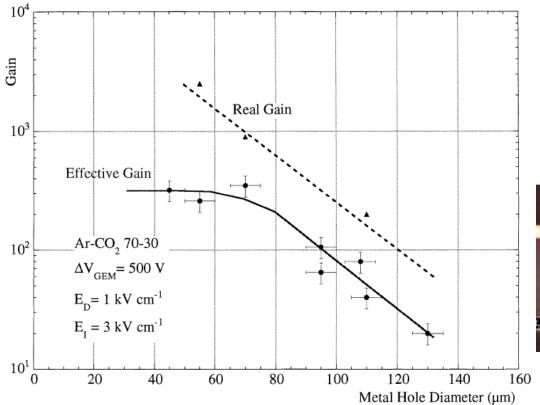




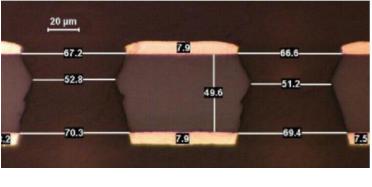
- The PCB factory guaranteed that the mechanical tolerance of the PCB is about 50ppm by using the Glass mask technology .(From Rui)
- > All the electronic connections should be correct.
- The surface of the readout strips smooth and no scratch & defect.



Effective gain .VS. Hole diameters

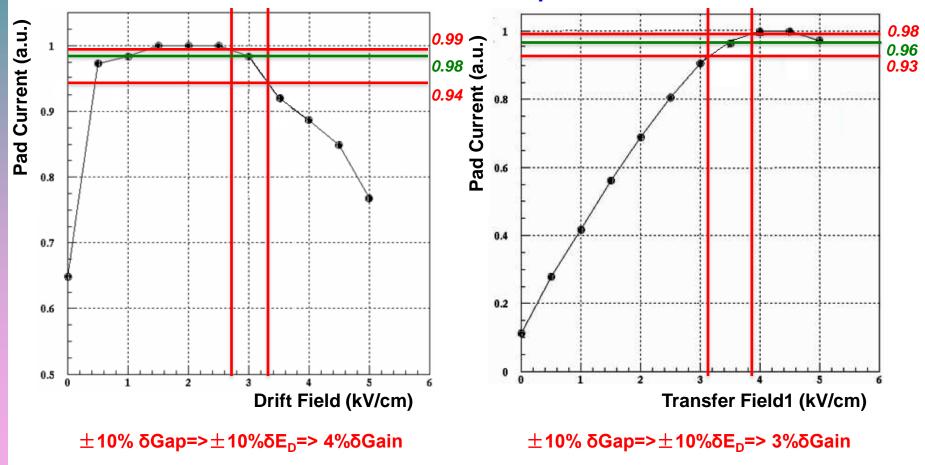


The effective gain saturates for the hole diameter from $50\mu m$ to $70\mu m$, so that we can ignore the effect from the tolerance of the hole diameter.



Mechanical tolerance of frame 1 & 2

The Mechanical tolerance of all frames & spacers is $\pm 10\%$



Mechanical tolerance of frame 3 & 4

0.96 Pad Current (a.u.) Pad Current (a.u.) 0.8 0.8 0.6 0.6 0.53 0.5 0.47 0.4 0.4 0.2 0.2 0 2 3 3 4 5 7 Transfer Field2 (kV/cm) Induction Field (kV/cm) ±10% δGap=>±10%δE_{T2}=> 5%δGain ±10% δGap=>±10%δE_{T1}=> 4%δGain

The Mechanical tolerance of all frames & spacers is $\pm 10\%$

ΔG_{eff} from *mechanical tolerance estimate*

Total ΔG_{eff} is :

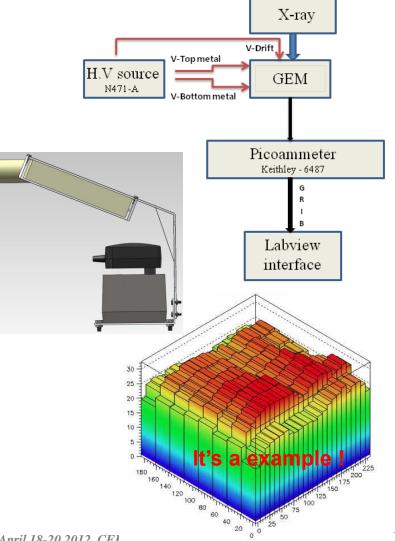
$$\mathcal{O} = \sqrt{(4\%)^2 + (3\%)^2 + (5\%)^2 + (4\%)^2} \gg 8.12\%$$

Gain uniformity test

Keep temperature & humidity constant Or Use a sensor to monitor the temperature

and humidity.

- Use the computer controlled step-motor to move the X-ray gun(or GEM);
- Use the convert-PCB to connect the readout strips in an area(need calculate) together;
- The gas gain should be performed by irradiating the triple-GEM prototype with the high intensity 8 keV X-ray tube.
 The current induced on the readout strips I, for a given X-ray flux Φ and irradiating area S, is proportional to the detector gain G, through the relation: I =e·N_γ ·S·Φ·G where e is the electron charge and N_γ is the gas ionization produced by the X-ray).



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Gas leak check

